

BAV199DW

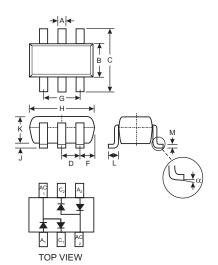
QUAD SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Surface Mount Package Ideally Suited for Automatic Insertion
- Very Low Leakage Current
- Lead Free/RoHS Compliant (Note 3)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin Solderable per MIL-STD-202,
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Please see Ordering Information, Page 3
- Polarity: See Diagram
- Marking: K52 & Date Code (See Page 3)
- Weight: 0.008 grams (approx.)



SOT-363								
Dim	Min	Max						
Α	0.10	0.30						
В	1.15	1.35						
С	2.00 2.20							
D	0.65 N	ominal						
F	0.30 0.40							
G	1.80	2.20						
Н	1.80 2.20							
J	0.10							
K	0.90 1.00							
L	0.25 0.40							
М	0.10	0.25						
α	0° 8°							
All Dimensions in mm								

Maximum Ratings @ TA = 25°C unless otherwise specified

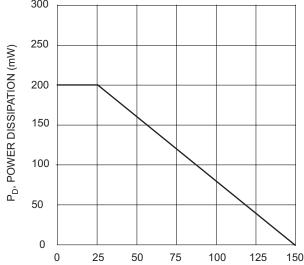
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	85	V
RMS Reverse Voltage	V _{R(RMS)}	60	V
Forward Continuous Current (Note 2) Single diode Double diode	I _{FM}	160 140	mA
Repetitive Peak Forward Current (Note 2)	I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current @ $t = 1.0 \mu s$ @ $t = 1.0 ms$ @ $t = 1.0 s$	I _{FSM}	4.0 1.0 0.5	А
Power Dissipation (Note 2)	P _d	200	mW
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	°C

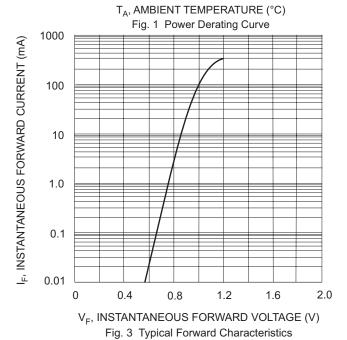
Electrical Characteristics @ $T_A = 25$ °C unless otherwise specified

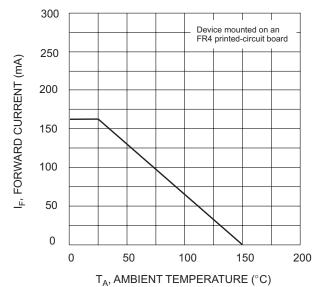
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	85	_	_	V	$I_R = 100 \mu A$
Forward Voltage	V _F	_	_	0.90 1.0 1.1 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Leakage Current (Note 1)	I _R		_	5.0 80	nA nA	$V_R = 75V$ $V_R = 75V$, $T_j = 150$ °C
Total Capacitance	Ст		2	_	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_	_	3.0	μS	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

- 1. Short duration test pulse to minimize self-heating effect.
- 2. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 3. No purposefully added lead.









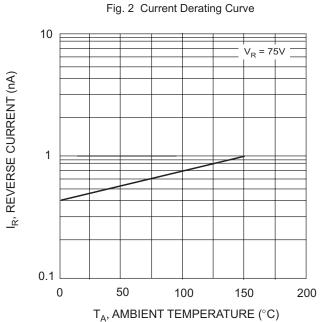


Fig. 4 Typical Reverse Characteristics

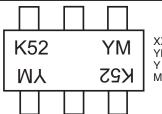


Ordering Information (Note 4)

Device	Packaging	Shipping		
BAV199DW-7-F	SOT-363	3000/Tape & Reel		

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXX = Product Type Marking Code YM = Date Code Marking Y = Year ex: T = 2006 M = Month ex: 9 = September

Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012
Code	Т	U	V	W	Х	Y	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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